

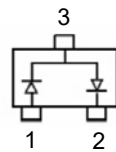
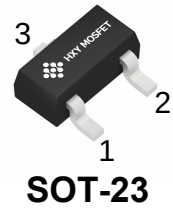


Features

- Peak Forward Current: $I_{FM}=200\text{mA}$
- Power Dissipation of 200mw

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
BAT54S	SOT-23	KL4	3000



Maxmim Ratings (Ta=25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V_{RRM} V_{RWM} V_R	30	V
Forward Continuous Current	I_{FM}	200	mA
Non-repetitive Peak Forward Surge Current @ t=8.3ms	I_{FSM}	600	mA
Repetitive Peak Forward Current @ t≤1s, δ≤0.5	I_{FRM}	300	mA
Power Dissipation	P_D	200	mW
Thermal Resistance from Junction to Ambient	$R_{\theta JA}$	500	°C/W
Operating Junction Temperature Range	T_j	-40 ~ +125	°C
Storage Temperature Range	T_{stg}	-55 ~ +150	°C

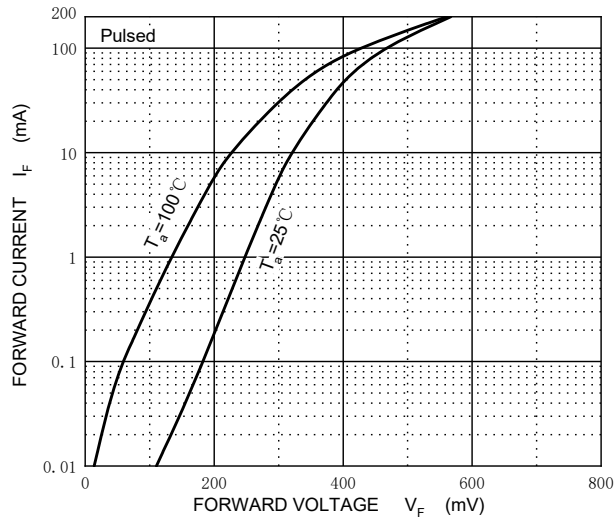
Electrcal Characteristics (Ta=25°C unless otherwise specified)

Parameter	Symbol	Min	Typ	Max	Unit	Test conditions
Reverse voltage	$V_{(BR)}$	30			V	$I_R=100\mu\text{A}$
Forward voltage	V_F			0.24	V	$I_{F1}=0.1\text{mA}$
				0.32	V	$I_{F2}=1\text{mA}$
				0.40	V	$I_{F3}=10\text{mA}$
				0.50	V	$I_{F4}=30\text{mA}$
				1	V	$I_{F5}=100\text{mA}$
Reverse current	I_R			2	μA	$V_R=25\text{V}$
Diode capacitance	C_D			10	pF	$V_R=1\text{V}, f=1\text{MHz}$
Reverse recovery time	t_{rr}			5	ns	$I_F=I_R=10\text{mA}$ $I_{rr}=0.1\times I_R, R_L=100\Omega$

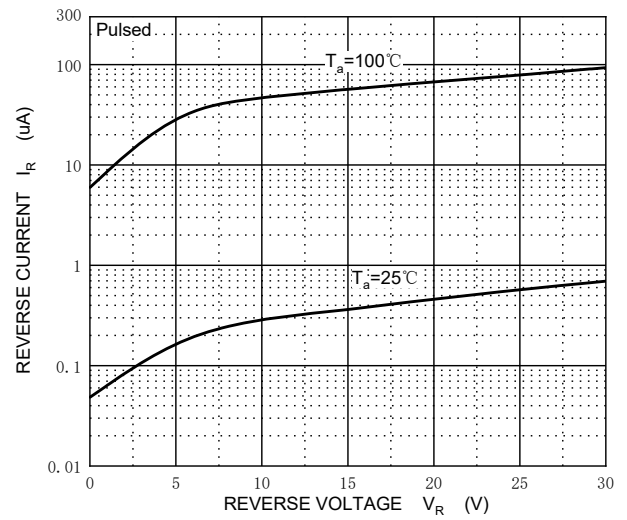


Typical Characteristics

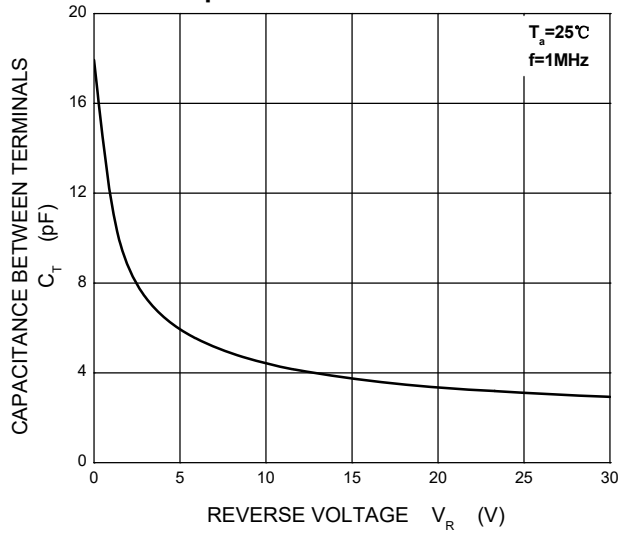
Forward Characteristics



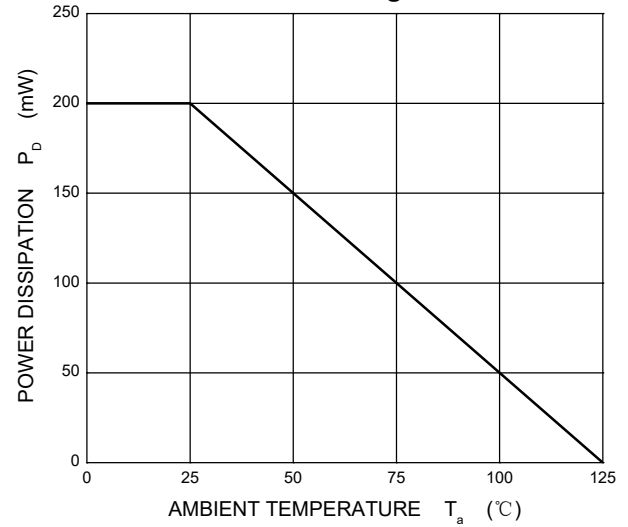
Reverse Characteristics



Capacitance Characteristics

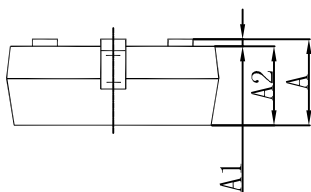
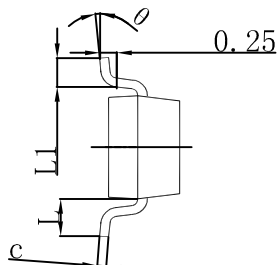
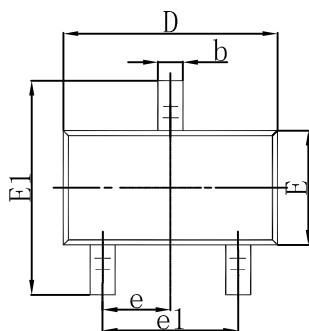


Power Derating Curve



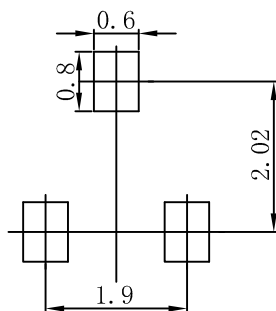


SOT-23 Package Outline Dimensions



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	0.900	1.150	0.035	0.045
A1	0.000	0.100	0.000	0.004
A2	0.900	1.050	0.035	0.041
b	0.300	0.500	0.012	0.020
c	0.080	0.150	0.003	0.006
D	2.800	3.000	0.110	0.118
E	1.200	1.400	0.047	0.055
E1	2.250	2.550	0.089	0.100
e	0.950 TYP		0.037 TYP	
e1	1.800	2.000	0.071	0.079
L	0.550 REF		0.022 REF	
L1	0.300	0.500	0.012	0.020
θ	0°	8°	0°	8°

SOT-23 Suggested Pad Layout



Note:
1. Controlling dimension: in millimeters.
2. General tolerance: $\pm 0.05\text{mm}$.
3. The pad layout is for reference purposes only.



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